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CLAIMS AS AMENDED UNDER ARTICLE 19

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CLAIMS

- 1. (Amended) A synthetic resin card comprising:
 - a substantially planar core layer; and

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a first outer layer and a second outer layer laminated on front and back surfaces of the core layer, respectively,

wherein the difference Δ in the angle of orientation between the first and second outer layers is 20° or less; and

- at least one of the first and second outer layers is provided with a recording layer.
 - 2. The synthetic resin card according to Claim 1, wherein the thicknesses of the first and second outer layers are symmetrical with respect to the core layer.
- 3. The synthetic resin card according to Claim 1, wherein the first and second outer layers each have a thickness of 25 to 125 $\mu m\,.$
 - 4. The synthetic resin card according to Claim 1, wherein the first and second outer layers are each formed of a biaxially oriented film.
 - 5. The synthetic resin card according to Claim 4, wherein the biaxially oriented film is composed of an oriented PET material.
- 6. The synthetic resin card according to Claim 1, wherein the core layer comprises an electronic module sandwiched

between a pair of core components.

- 7. The synthetic resin card according to Claim 6, wherein the electronic module comprises an IC chip and an IC module connected to the IC chip.
 - 8. (Canceled)

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- 9. (Amended) The synthetic resin card according to Claim
 1, wherein the recording layer is composed of a reversible
 thermosensitive material.
- 10. The synthetic resin card according to Claim 1,

 wherein the core layer is composed of a copolymer of
 terephthalic acid, cyclohexanedimethanol, and ethylene
 glycol, and polycarbonate, the compounding ratio of the
 copolymer being 70% or less.
- 11. The synthetic resin card according to Claim 1,
 15 wherein the core layer and the first and second outer layers are each composed of a halogen-free material.
 - 12. (Amended) A method for producing a synthetic resin card comprising laminating a first outer layer and a second outer layer on front and back surfaces of a substantially planar core layer,

wherein the first and second outer layers are selected so that the difference Δ in the angle of orientation between the first and second outer layers is 20° or less;

the first and second outer layers are laminated so that

the thicknesses of the first and second outer layers are

symmetrical with respect to the core layer; and
a recording layer is formed on at least one of the
first outer layer and the second outer layer.

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